L Number	Hits	Search Text	DB	Time stamp
1	1561	(chip die IC) and (lead adj frame) and solder and (heat adj (sink plate slug element spreader dissipat$4)) and solder	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/27 12:58
2	7	("4063984" | "5300627" | "5508357" | "5510425" | "5851616" | "5866250" | "5891540").PN.	USPAT	2004/02/27 11:39
3	7	("4063984" | "5300627" | "5508357" | "5510425" | "5851616" | "5866250" | "5891540").PN.	USPAT	2004/02/27 11:39
4	2	("5367196").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/27 11:45
5	28	("3770600" | "3784440" | "4092697" | "4121980" | "4461924" | "4589010" | "4640625" | "4707724" | "4713150" | "4766095" | "4767674" | "4888449" | "4926242" | "4939316" | "4994314" | "5013871" | "5015803" | "5023398" | "5038940" | "5055967" | "5066368" | "5073521" | "5098796" | "5098864" | "5122858" | "5124783" | "5155299" | "5181969").PN.	USPAT	2004/02/27 11:45
6	11	("4862245" | "4984059" | "5184208" | "5252853" | "5286679" | "5304842" | "5440169" | "5441684" | "5461255" | "5598034" | "5604376").PN.	USPAT	2004/02/27 12:06
7	11	("4862245" | "4984059" | "5184208" | "5252853" | "5286679" | "5304842" | "5440169" | "5441684" | "5461255" | "5598034" | "5604376").PN.	USPAT	2004/02/27 12:19
8	11	("4862245" | "4984059" | "5184208" | "5252853" | "5286679" | "5304842" | "5440169" | "5441684" | "5461255" | "5598034" | "5604376").PN.	USPAT	2004/02/27 12:19
9	9	("4663833" | "4672418" | "4672421" | "4723156" | "4727221" | "4784974" | "4926242" | "4994897" | "5105259").PN.	USPAT	2004/02/27 12:21
10	11	("4862245" | "4984059" | "5184208" | "5252853" | "5286679" | "5304842" | "5440169" | "5441684" | "5461255" | "5598034" | "5604376").PN.	USPAT	2004/02/27 12:21
11	16	(chip die IC) and (lead adj frame) and (heat adj (sink plate slug element spreader dissipat$4)) with wider and solder	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/27 13:26
12	2	("5959349").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/27 13:26
–	52	(lead adj frame) and (chip die IC) and (metal adj block)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/26 17:32
–	4	("3930114" | "4396936" | "4594770" | "5041902").PN.	USPAT	2004/02/26 17:23
–	7	("3786317" | "4012765" | "4012768" | "4415025" | "4630172" | "4698663" | "4712129").PN.	USPAT	2004/02/26 17:24
–	6	("3444309" | "3629672" | "3689683" | "3729573" | "3767839" | "3839660").PN.	USPAT	2004/02/26 17:30

–	1979	(lead adj frame) and (chip die IC) and (heat adj sink)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/26 17:32
–	1115	(lead adj frame) and (chip die IC) and (heat adj sink) and insulat$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/26 17:37
–	154	(chip die IC) and (lead adj frame) with solder and (heat adj sink) and insulat$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/26 20:03
–	6	("5077595" | "5699609" | "5751063" | "5920119" | "5942797" | "6018463").PN.	USPAT	2004/02/26 17:44
–	10	("3702427" | "4495378" | "4577056" | "4939316" | "4967260" | "5013871" | "5025114" | "5034591" | "5132773" | "5367196").PN.	USPAT	2004/02/26 17:48
–	28	("3770600" | "3784440" | "4092697" | "4121980" | "4461924" | "4589010" | "4640625" | "4707724" | "4713150" | "4766095" | "4767674" | "4888449" | "4926242" | "4939316" | "4994314" | "5013871" | "5015803" | "5023398" | "5038940" | "5055967" | "5066368" | "5073521" | "5098796" | "5098864" | "5122858" | "5124783" | "5155299" | "5181969").PN.	USPAT	2004/02/26 17:51
–	87	(chips dice) and (lead adj frame) with solder and (heat adj sink) and insulat$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/26 18:36
–	36	(chips dice) and (lead adj frame) and (heat adj sink) with block$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/26 18:46
–	7	("5057906" | "5466969" | "5703399" | "6060772" | "6066890" | "6083772" | "6313520").PN.	USPAT	2004/02/26 18:39
–	7	("5057906" | "5466969" | "5703399" | "6060772" | "6066890" | "6083772" | "6313520").PN.	USPAT	2004/02/26 18:40
–	3	("5057906" | "5424250" | "5466969").PN.	USPAT	2004/02/26 18:41
–	387	(chips dice) and (heat adj sink) with block$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/26 19:10
–	0	toshiaki-shinohara.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/26 19:10
–	0	shinohara-shinohara.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/26 19:11
–	195	shinohara-toshiaki.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/26 19:28

-	2	("5041902").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/26 19:56
-	7	("3786317" | "4012765" | "4012768" | "4415025" | "4630172" | "4698663" | "4712129").PN.	USPAT	2004/02/26 19:29
-	2	("5367196").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/26 19:56
-	28	("3770600" | "3784440" | "4092697" | "4121980" | "4461924" | "4589010" | "4640625" | "4707724" | "4713150" | "4766095" | "4767674" | "4888449" | "4926242" | "4939316" | "4994314" | "5013871" | "5015803" | "5023398" | "5038940" | "5055967" | "5066368" | "5073521" | "5098796" | "5098864" | "5122858" | "5124783" | "5155299" | "5181969").PN.	USPAT	2004/02/26 20:01
-	210	(chip die IC) and (lead adj frame) with solder and (heat adj sink) and (resin packag$4 encapsul$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/26 20:04
-	40	("3324224" | "4313492" | "4335781" | "4480262" | "4561040" | "4603374" | "4727455" | "4740866" | "4806503" | "4825284" | "4888449" | "4897508" | "4912548" | "4939316" | "4949219" | "4961106" | "4967260" | "5015803" | "5018005" | "5023398" | "5025114" | "5055967" | "5066368" | "5073521" | "5103292" | "5175613" | "5184211" | "5189505" | "5214308" | "5216283" | "5235209" | "5256205" | "5284706" | "5291064" | "5323292" | "5324569" | "5334857" | "5352926" | "5353193" | "5380212").PN.	USPAT	2004/02/26 20:20
-	2	("5650663").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/27 11:13
-	39	("3676292" | "3697666" | "3726987" | "3728177" | "3740920" | "3914858" | "3993123" | "4105861" | "4149910" | "4410927" | "4461924" | "4468293" | "4480262" | "4481525" | "4491622" | "4500605" | "4515671" | "4521469" | "4524238" | "4525422" | "4532222" | "4542259" | "4551210" | "4552206" | "4570337" | "4577056" | "4582556" | "4594770" | "4607276" | "4649083" | "4651192" | "4656499" | "4682414" | "4696851" | "4704626" | "4707724" | "4712161" | "4725333" | "4796083").PN.	USPAT	2004/02/26 20:32
-	10	("3702427" | "4495378" | "4577056" | "4939316" | "4967260" | "5013871" | "5025114" | "5034591" | "5132773" | "5367196").PN.	USPAT	2004/02/26 20:35